300MHz–960MHz ASK and (G)FSK Transmitter with SPI Interface

General Description

The MAX41460 is a UHF sub-GHz ISM/SRD transmitter is designed to transmit On-Off Keying (OOK), Amplitude-Shift Keying (ASK), Frequency-Shift Keying (FSK), and Gaussian (G)FSK (or 2GFSK) data in the 286MHz to 960MHz frequency range. It integrates a fractional phaselocked-loop (PLL) so that a single, low-cost crystal can be used to generate commonly used world-wide sub-GHz frequencies. The fast response time of the PLL allows for frequency-hopping, spread spectrum protocols for increased range and security. The only frequency-dependent components required are for the external antenna-matching network.

The crystal-based architecture of the MAX41460 provides greater modulation depth, faster frequency settling, higher tolerance of the transmit frequency, and reduced temperature dependence.

The MAX41460 provides output power up to +13dBm into a 50 Ω load while only drawing < 8mA for ASK (Manchester coded) and < 12mA for (G)FSK transmission at 315MHz. The output load can be adjusted to increase power up to +16dBm, and a PA boost mode can be enabled at frequencies above 850MHz to compensate for losses. The PA output power can also be controlled using programmable register settings.

The MAX41460 features single-supply operation from +1.8V to +3.6V. The device has an auto-shutdown feature to extend battery life and a fast oscillator wake-up on data activity detection. A serial programmable interface make the MAX41460 compatible with almost any microcontroller or code-hopping generator.

The MAX41460 is available in a 10-pin μ MAX package and is specified over the -40°C to +105°C extended temperature range. The MAX41460 has an ESD rating of 2.5kV HBM.

Applications

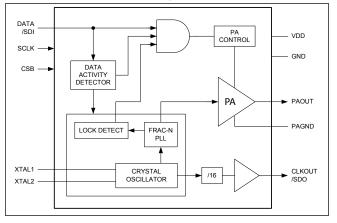
- Building Automation and Security
- Wireless Sensors and Alarms
- Remote and Passive Keyless Entry (RKE/PKE)
- Tire Pressure Monitoring Systems (TPMS)
- Automatic Meter Reading (AMR)
- Garage Door Openers (GDO)
- Radio Control Toys
- Internet of Things (IoT)

Benefits and Features

- Low Implementation Cost
 - Bits-to-RF Single-Wire Operation
 - Low Bill-of-Materials (BoM)
 - Uses Single, Low-Cost, 16MHz Crystal
 - Small 3mm x 3mm µMAX-10 Package
- Increased Range, Data Rates, and Security
 - Up to +16dBm PA Output Power
 - Fast Frequency Switching for FHSS/DSSS
 - Fast-On Oscillator: < 250µs Startup Time
 - Up to 200kbps NRZ Data Rate
- Extend Battery Life with Low Supply Current
 - < 8mA ASK Manchester Coded
 - < 12mA (G)FSK or 2GFSK at 315MHz
 - Selectable Standby and Shutdown Modes
 - Auto Shutdown at < 20nA (typ) Current
- Ease-of-Use
 - +1.8V to +3.6V Single-Supply Operation
 - Fully Programmable with SPI Interface
 - 400kHz/1MHz I²C Versions Also Available

Ordering Information appears at end of data sheet.

Simplified Block Diagram





300MHz–960MHz ASK and (G)FSK Transmitter with SPI Interface

Absolute Maximum Ratings

V _{DD} to GND0.3V to +4V	Junction Temperature+150°C
All Others Pins to GND0.3V to (V _{DD} + 0.3)V	Storage Temperature Range60°C to +150°C
Continuous Power Dissipation ($T_A = +70^{\circ}C$, derate 5.6mW/ $^{\circ}C$	Lead Temperature (reflow)+300°C
above +70°C)	Soldering Temperature (reflow)+260°C
Operating Temperature Range40°C to +105°C	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Information

10 µMAX (similar to 10 TSSOP)

Package Code	U10+2
Outline Number	<u>21-0061</u>
Land Pattern Number	<u>90-0330</u>
Thermal Resistance, Single-Layer Board:	
Junction-to-Ambient (θ _{JA})	180°C/W
Junction-to-Case Thermal Resistance (θ_{JC})	36°C/W
Thermal Resistance, Four-Layer Board:	
Junction-to-Ambient (θ _{JA})	113.1°C/W
Junction-to-Case Thermal Resistance (θ_{JC})	36°C/W

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <u>www.maximintegrated.com/</u> <u>thermal-tutorial</u>.

300MHz–960MHz ASK and (G)FSK Transmitter with SPI Interface

Electrical Characteristics

(<u>Typical Application Circuit</u> , all RF inputs and outputs are referenced to 50Ω , V_{DD} = +1.8V to +3.6V, T_A = -40°C to +105°C, P_{OUT} =
+13dBm for 300MHz–450MHz or +11dBm for 863MHz–928MHz, PA_BOOST = 0, unless otherwise noted. Typical values are at V_{DD}
= +3V, T _A = +25°C, unless otherwise noted. (Note 1))

PARAMETER	SYMBOL	COND	ITIONS	MIN	ТҮР	MAX	UNITS
DC CHARACTERISTICS	;						
		V _{DATA} at 50% duty cycle (ASK) (Note 3, Note 4)	f _{RF} = 315MHz		7	12	
			f _{RF} = 434MHz		8	12	1
			f _{RF} = 863MHz– 928MHz		10	19	
		V _{DATA} at 50% duty	f _{RF} = 315MHz, P _{OUT} = 16dBm (Note 5)		24		
		cycle (ASK) (Note 3, Note 4)	f _{RF} = 434MHz, P _{OUT} = 16dBm (Note 5)		26		
		f _{RF} = 863MHz– 928MHz, P _{OUT} = 16dBm, PA_BOOST = 1 (Note 5)		45			
		V _{DATA} at 50% duty	f _{RF} = 315MHz		9.5		1
Operating Current I _{DD}	cycle (ASK), Low	f _{RF} = 434MHz		10.5			
	I _{DD}	Phase Noise mode (Note 3, Note 4)	f _{RF} = 863MHz–928MHz		12.8		mA
- p	.00		f _{RF} = 315MHz		12	21	
			f _{RF} = 434MHz		13	27.5	
			f _{RF} = 863MHz–928MHz		19	39	
			f _{RF} = 315MHz, P _{OUT} = 16dBm (Note 5)		28		
		FSK (Note 2)	f _{RF} = 434MHz, P _{OUT} = 16dBm (Note 5)		27		
		f _{RF} = 863MHz–928MHz, P _{OUT} = 16dBm, PA_BOOST = 1 (Note 5)		43			
			f _{RF} = 315MHz		15		1
		FSK, Low Phase Noise mode (Note	f _{RF} = 434MHz		17		1
		2)	f _{RF} = 863MHz–928MHz		20.5		
		PA off (Note 2)	f _{RF} = 315MHz		2	3	1

300MHz–960MHz ASK and (G)FSK Transmitter with SPI Interface

Electrical Characteristics (continued)

(<u>Typical Application Circuit</u>, all RF inputs and outputs are referenced to 50Ω , V_{DD} = +1.8V to +3.6V, T_A = -40°C to +105°C, P_{OUT} = +13dBm for 300MHz-450MHz or +11dBm for 863MHz-928MHz, PA_BOOST = 0, unless otherwise noted. Typical values are at V_{DD} = +3V, T_A = +25°C, unless otherwise noted. (Note 1))

PARAMETER	SYMBOL	CONE	CONDITIONS		TYP	MAX	UNITS
			f _{RF} = 434MHz		2	3	
			f _{RF} = 863MHz–928MHz		3	4]
			f _{RF} = 315MHz		4		1
		PA off, Low Phase Noise mode (Note	f _{RF} = 434MHz		4]
		2)	f _{RF} = 863MHz–928MHz		5		
Supply Voltage	V _{DD}	PA_BOOST = 0		1.8	3	3.6	v
Supply vollage	۷DD	PA_BOOST = 1		1.8	2.7	3.0	v
Standby Current	ISTDBY	Crystal oscillator	T _A = 25°C		200	500	- μA
Standby Sumeric	SIDBY	on, everything off.	T _A = 105°C		250		
Shutdown Current	I _{SHDN}	Everything off	T _A = 25°C		19	100	nA
MODULATION PARAME	TERS						
ASK Modulation Depth		Supply current and o greatly dependent o PAOUT match			70		dB
FSK Frequency Deviation		Default value			±39		kHz
FSK Minimum Frequency Deviation					±1		kHz
FSK Minimum Frequency Deviation for Gaussian Shaping					±10		kHz
FSK Maximum Frequency Deviation					±100		kHz
Minimum MSK Data Rate		FSK modulation inde	ex = 0.5		4		kbps
Maximum NRZ Data Rate					200		kbps
POWER AMPLIFIER							
		f _{RF} = 300MHz-450M	MHz (Note 4)		13		
		f _{RF} = 300MHz-450M	MHz (Note 4, Note 5)		17		
Output Power	POUT	f _{RF} = 863MHz–928M	MHz (Note 4)		11		dBm
		f _{RF} = 863MHz–928MHz (Note 4, Note 5), PA_BOOST = 1			16		
Maximum Carrier Harmonics		PA_BOOST = 0. Su power, and harmoni board layout and PA	cs are dependent on		-24		dBc

300MHz–960MHz ASK and (G)FSK Transmitter with SPI Interface

Electrical Characteristics (continued)

(<u>Typical Application Circuit</u>, all RF inputs and outputs are referenced to 50Ω , V_{DD} = +1.8V to +3.6V, T_A = -40°C to +105°C, P_{OUT} = +13dBm for 300MHz-450MHz or +11dBm for 863MHz-928MHz, PA_BOOST = 0, unless otherwise noted. Typical values are at V_{DD} = +3V, T_A = +25°C, unless otherwise noted. (Note 1))

PARAMETER	SYMBOL	CONDITIONS		MIN	ТҮР	MAX	UNITS	
PLL								
		Low Current mode (c	lefault)	286		960		
			ode, LODIV = DIV12	286.7		320		
Frequency Range		Low Phase Noise mo	ode, LODIV = DIV8	425		480	- MHz	
		Low Phase Noise mo	ode, LODIV = DIV4	860		960		
		f _{RF} = 315MHz, Low	f _{OFFSET} = 200kHz		-82			
		Current mode (default)	f _{OFFSET} = 1MHz		-90			
PLL Phase Noise		f _{RF} = 434MHz,	f _{OFFSET} = 200kHz		-80		dBc/Hz	
T LE T Hase Noise		Low Current mode (default)	f _{OFFSET} = 1MHz		-90		UDC/112	
		f _{RF} = 915MHz, Low	f _{OFFSET} = 200KHz		-82			
		Phase Noise mode	f _{OFFSET} = 1MHz		-104			
					4			
LO Divider Settings					8			
					12			
Minimum Synthesizer					fxtal/		Hz	
Frequency Step					2 ¹⁶			
		f _{RF} = 315MHz	f _{RF} ± f _{XTAL}		-67			
Reference Spur		f _{RF} = 434MHz	f _{RF} ± f _{XTAL}		-60		dBc	
		f _{RF} = 868MHz	f _{RF} ± f _{XTAL}		-57		dDC	
		f _{RF} = 915MHz	f _{RF} ± f _{XTAL}		-56			
Reference Frequency Input Level					500		mV _{P-P}	
Frequency Switching Time		26MHz frequency ste 928MHz band, time t write to frequency se of desired carrier	rom end of register		50		μs	
Loop Bandwidth	LBW				300		kHz	
LO Frequency Divider Range	Ν			11		72		
		f _{RF} = 315MHz			30			
		f _{RF} = 915MHz			90		- μs	
CRYSTAL OSCILLATOR							1	
Crystal Frequency	f _{XTAL}	Recommended value	e (Note 3)	12.8	16	19.2	MHz	
Crystal Oscillator Startup Time	t _{XO}	See Preset Mode Tra	ansmission section		243		μs	
Frequency Pulling by V _{DD}					3		ppm/V	

300MHz–960MHz ASK and (G)FSK Transmitter with SPI Interface

Electrical Characteristics (continued)

(*Typical Application Circuit*, all RF inputs and outputs are referenced to 50Ω , V_{DD} = +1.8V to +3.6V, T_A = -40°C to +105°C, P_{OUT} = +13dBm for 300MHz–450MHz or +11dBm for 863MHz–928MHz, PA_BOOST = 0, unless otherwise noted. Typical values are at V_{DD} = +3V, T_A = +25°C, unless otherwise noted. (Note 1))

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Crystal Input Capacitance	C _X	Internal capacitance XTAL2 pins to grour			12		pF
CMOS INPUT/OUTPUT				·			
Input Low Voltage	VIL	SCLK/DATA/CSB	1.8V compatible			0.36	V
Input High Voltage	VIH	SCLK/DATA/CSB	1.8V compatible	1.44			V
Input Current	IIL/IIH				±10		μA
Input Current	IIL/IIH	Pin CSB, internal pu	Illup resistor			65	μA
Output Low Voltage	V _{OL}	I _{SINK} = 650μA			0.25		V
Output High Voltage	V _{OH}	I _{SOURCE} = 350μA			V _{DD} - 0.25		V
Maximum Load Capacitance at CLKOUT/SDO Pin	C _{LOAD}				10		pF
SERIAL INTERFACE	(FIGURE 1)	_		•			
SCLK Frequency	f SCLK	1/t _{SCLK}				20	MHz
SCLK to CSB Setup Time	tcss				10		ns
SCLK to CSB Hold Time	t _{CSH}				0		ns
SDI to SCLK Hold Time	t _{SDH}	Data-write			0		ns
SDI to SCLK Setup Time	t _{SDS}	Data-write	Data-write		5		ns
Minimum SCLK to SDI		Data-read, 10pF loa Ground	d from SDO to		1.5		
Data Delay	^t SDD_MIN	Data-read, 100pF load from SDO to Ground			3.5		- ns
Maximum SCLK to SDI		Data-read, 10pF loa Ground	d from SDO to		8		
Data Delay	^t SDD_MAX	Data-read, 100pF lo Ground	Data-read, 100pF load from SDO to Ground		11		- ns

Note 1: Supply current, output power and efficiency are greatly dependent on board layout and PA output match.

Note 2: 100% tested at $T_A = +25^{\circ}C$. Limits over operating temperature and relevant supply voltage are guaranteed by design and characterization over temperature.

Note 3: Guaranteed by design and characterization. Not production tested.

Note 4: Typical values are average, peak power is 3dB higher.

Note 5: Using high output power match, see <u>Table 2</u>.

300MHz–960MHz ASK and (G)FSK Transmitter with SPI Interface

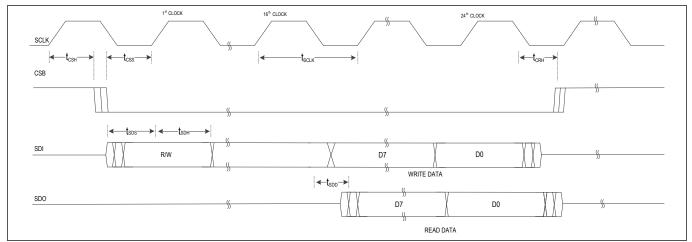
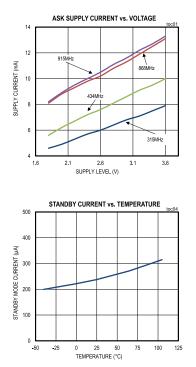


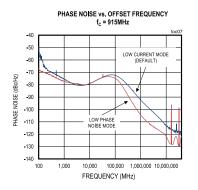
Figure 1. Serial Interface Timing Diagram

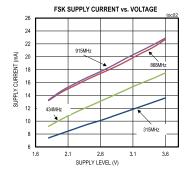
300MHz–960MHz ASK and (G)FSK Transmitter with SPI Interface

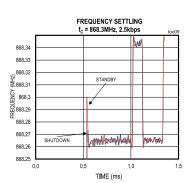
Typical Operating Characteristics

(Typical Application Circuit, RF output terminated to 50Ω . Typical values are at V_{DD} = +3V, T_A = +25°C, unless otherwise noted.)

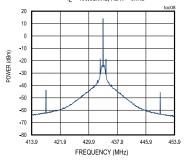


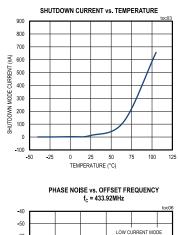


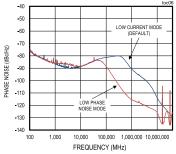


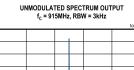








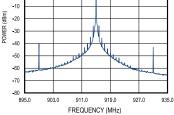




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10

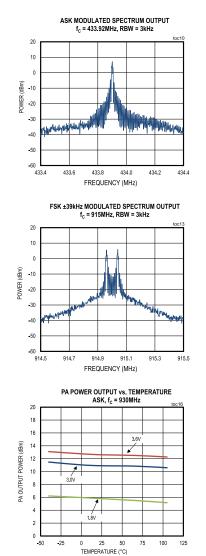
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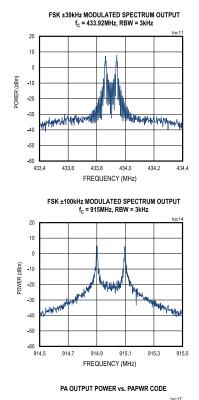


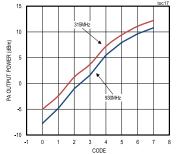
300MHz–960MHz ASK and (G)FSK Transmitter with SPI Interface

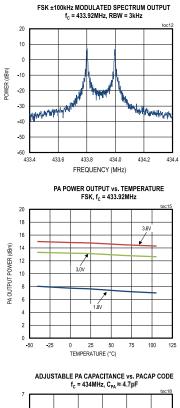
Typical Operating Characteristics (continued)

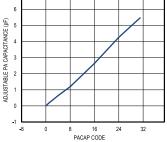
(Typical Application Circuit, RF output terminated to 50Ω . Typical values are at V_{DD} = +3V, T_A = +25°C, unless otherwise noted.)







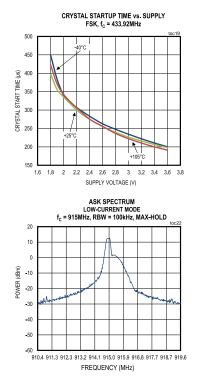


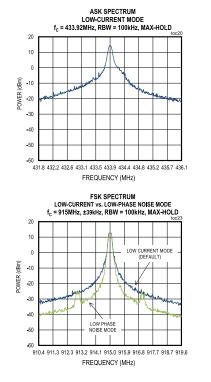


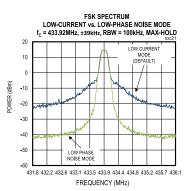
300MHz–960MHz ASK and (G)FSK Transmitter with SPI Interface

Typical Operating Characteristics (continued)

(Typical Application Circuit, RF output terminated to 50Ω . Typical values are at V_{DD} = +3V, T_A = +25°C, unless otherwise noted.)



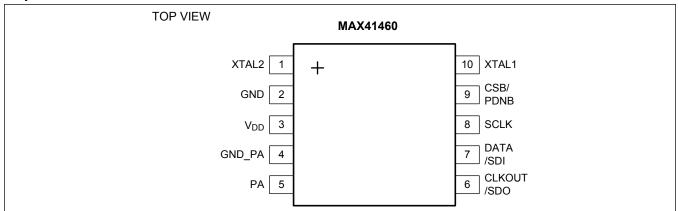




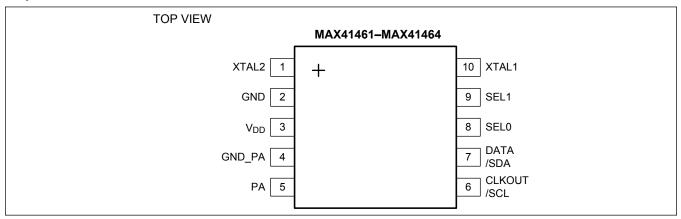
300MHz–960MHz ASK and (G)FSK Transmitter with SPI Interface

Pin Configurations

10 µMAX



10 µMAX



300MHz–960MHz ASK and (G)FSK Transmitter with SPI Interface

Pin Description

P	IN		
MAX4146 0	MAX4146 1–MAX41 464	NAME	FUNCTION
XTAL2	XTAL2	1	Second Crystal Input. See Crystal Oscillator section.
GND	GND	2	Ground. Connect to system ground.
V _{DD}	V _{DD}	3	Supply Voltage. Bypass to GND with a 100nF capacitor as close to the pin as possible.
GND_PA	GND_PA	4	Ground for the Power Amplifier (PA). Connect to system ground.
PA	PA	5	Power-Amplifier Output. The PA output requires a pullup inductor to the supply voltage, which can be part of the output-matching network to an antenna.
CLKOUT/ SDO	CLKOUT/ SCL	6	MAX41460: Buffered Clock Output or SPI Data Output. MAX41461–MAX41464: Buffered Clock Output. I ² C clock input for register programming when in Serial Interface Mode (SEL0 and SEL1 are unconnected or HIZ). The frequency of CLKOUT is 800kHz when not in Program mode.
DATA/SDI	DATA/ SDA	7	MAX41460: Data Input. SPI bus serial data input for register programming when CSB is at logic-low. MAX41461–MAX41464: Data Input. I ² C serial data input for register programming when in Serial Interface mode (SEL0 and SEL1 are unconnected or HIZ). When not in Program mode, DATA also controls the power-up state (see the <i>Auto-Shutdown in Preset Mode</i> section in the appropriate data sheet).
SCLK	SEL0	8	MAX41460: SPI Bus Serial Clock Input. MAX41461–MAX41464: Three-state Mode Input. See <i>Preset Modes</i> section in the appropriate data sheet for details. For three-state input open, the impedance on the pin must be greater than 1MΩ.
CSB	SEL1	9	MAX41460: SPI Bus Chip Enable. Active Low. MAX41461–MAX41464: Three-state Mode Input. See <i>Preset Modes</i> section in the appropriate data sheet for details. For three-state input open, the impedance on the pin must be greater than 1MΩ.
XTAL1	XTAL1	10	First Crystal Input. See Crystal Oscillator section.

Detailed Description

The MAX41460 is part of the MAX4146x family of UHF sub-GHz ISM/SRD transmitters designed to transmit ASK and (G)FSK data in the 286MHz to 960MHz frequency range. The MAX4146x family is available in the following versions.

Table 1. MAX4146x Versions

VERSION	MODULATION AND INTERFACE	PRESET FREQUENCIES (MHz)
MAX41460	ASK/FSK with SPI	No presets, programmable through SPI
MAX41461	ASK (optional I ² C)	315/318/319.51/345/433.42/433.92/908/915
MAX41462	ASK (optional I ² C)	315/433/433.92/434/868/868.3/868.35/868.5
MAX41463	FSK (optional I ² C)	315/433.42/433.92/908/908.42/908.8/915/916
MAX41464	FSK (optional I ² C)	315/433.92/868.3/868.35/868.42/868.5/868.95/869.85

The MAX41460 uses an SPI programming interface. The MAX41461–MAX41464 feature an I²C interface, as well as preset modes (pin-selectable output frequencies using only one crystal frequency). No programming is required in preset modes and only a single-input data interface to an external microcontroller is needed. The MAX41460 parts are identical when put in I²C programming mode. All MAX4146x versions are fully programmable for all output frequencies, as described in the <u>Electrical Characteristics</u> table. The only frequency-dependent components required are for the the external antenna match.

The crystal-based architecture of the MAX41460 provides greater modulation depth, faster frequency settling, higher tolerance of the transmit frequency, and reduced temperature dependence. It integrates a fractional phase-locked-loop (PLL); so a single, low-cost crystal can be used to generate commonly used world-wide sub-GHz frequencies. A buffered clock-out signal make the device compatible with almost any microcontroller or code-hopping generator.

The MAX41460 provides +13dBm output power into a 50Ω load at 315MHz using an integrated high efficiency power amplifier (PA). The output load can be adjusted to increase power up to +16dBm and a PA boost mode can be enabled at frequencies above 850MHz to compensate for losses. The PA output power can also be controlled using programmable register settings. The MAX41460 feature fast oscillator wake-up upon data activity detection and has an auto-shutdown feature to extend battery life.

The MAX41460 operates at a supply voltage of +1.8V to +3.6V and is available in a 10-pin μ MAX package that is specified over the -40°C to +105°C extended temperature range.

Power Amplifier

The MAX41460 PA is a high-efficiency, open-drain switching-mode amplifier. In a switching-mode amplifier, the gate of the final-stage FET is driven with a 25% duty-cycle square wave at the transmit frequency. The PA also has an internal set of capacitors that can be switched in and out to present different capacitance values at the PA output using the PACAP[4:0] register values. This allows extra flexibility for tuning the output matching network. When the matching network is tuned correctly, the output FET resonates the attached tank circuit (pullup inductor from PA to V_{DD}) with a minimum amount of power dissipated in the FET. With a proper output-matching network, the PA can drive a wide range of antenna impedances, which include a PCB trace antenna or a 50 Ω antenna. The output-matching π -network suppresses the carrier harmonics and transforms the antenna impedance to an optimal impedance at the PA pin. The *Typical Application Circuit* can deliver an output power of +13dBm with a +3.0V supply. Table 2 has approximate PA load impedances for desired output powers.

The PAPWR bits in the PA1 register control the output power of the PA. This setting adjust the number of parallel drivers used, which determine the final output power (see Figure 2).

300MHz–960MHz ASK and (G)FSK Transmitter with SPI Interface

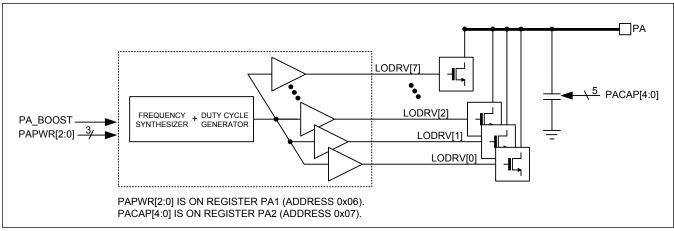


Figure 2. Power Amplifier

Boost Mode

The PA can deliver up to 16dBm of output power.

High output power can be achieved in two ways:

- Lower the load impedance for the PA by adjusting the output matching network,
- For frequencies over 850MHz, change the duty cycle of the square wave driving the PA from 25% to 50% by setting PA_BOOST = 1 in register SHDN (0x05) and adjusting the output matching network.

Note that, when using PA_BOOST = 1, the maximum supply voltage should not exceed 3V. For frequencies under 850MHz, the PA_BOOST bit should remain at 0, the output match can be adjusted to provide higher output power.

Table 2. PA Load Impedance for Desired Output Power

FREQUENCY (MHz)	OUTPUT POWER (dBm)	ΡΑ LOAD IMPEDANCE (Ω)
315	13	165
315	16 (PA_BOOST = 0)	45
434	13	180
434	16 (PA_BOOST = 0)	57
863–928	11	190
863–928	16 (PA_BOOST = 1)	34

Refer to the MAX4146x EV Kit User's Guide for details.

Programmable Output Capacitance

The MAX41460 has an internal set of capacitors that can be switched in and out to present different capacitor values at the PA output. The capacitors are connected from the PA output to ground. This allows changing the tuning network along with the synthesizer divide ratio each time the transmitted frequency changes, making it possible to maintain maximum transmitter power while moving rapidly from one frequency to another.

The variable capacitor is programmed through register PA2 (0x07) bits 4:0 (PACAP). The tuning capacitor has a nominal resolution of 0.18pF, from 0pF to 5.4pF. In preset mode, the variable capacitor is set to 0pF.

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Transmitter Power Control

The transmitter power of the MAX41460 can be set in approximately 2.5dB steps by setting PAPWR[2:0] register bits using the SPI interface. The transmitted power (and the transmitter current) can be lowered by increasing the load impedance on the PA. Conversely, the transmitted power can be increased by lowering the load impedance.

Crystal (XTAL) Oscillator

The XTAL oscillator in the MAX41460 is designed to present a capacitance of approximately 12pF from the XTAL1 and XTAL2 pins to ground. In most cases, this corresponds to a 6pF load capacitance applied to the external crystal when typical PCB parasitics are included. It is very important to use a crystal with a load capacitance equal to the capacitance of the MAX41460 crystal oscillator plus PCB parasitics. If a crystal designed to oscillate with a different load capacitance is used, the crystal is pulled away from its stated operating frequency introducing an error in the reference frequency. The crystal's natural frequency is typically below its specified frequency. However, when loaded with the specified load capacitance, the crystal is pulled and oscillates at its specified frequency. This pulling is already accounted for in the specification of the load capacitance. Accounting for typical board parasitics, a 16MHz, 12pF crystal is recommended. Please note that adding discrete capacitance on the crystal also increases the startup time and adding too much capacitance could prevent oscillation altogether.

Additional pulling can be calculated if the electrical parameters of the crystal are known. The frequency pulling is given by:

$$f_{P} = \frac{C_{M}}{2} \left(\frac{1}{C_{CASE} + C_{LOAD}} - \frac{1}{C_{CASE} + C_{SPEC}} \right) \times 10^{6}$$

where:

f_P is the amount the crystal frequency pulled in ppm.

 C_M is the motional capacitance of the crystal.

C_{CASF} is the case capacitance.

C_{SPEC} is the specified load capacitance.

CLOAD is the load capacitance.

When the crystal is loaded as specified (i.e., $C_{LOAD} = C_{SPEC}$), the frequency pulling equals zero. For additional details on crystal pulling and load capacitance affects, refer to *Maxim Tutorial 5422 – Crystal Calculations for ISM RF Products*.

Turn-On Time of Crystal Oscillator

The turn-on time of crystal oscillator (XO), t_{XO}, is defined as elapsed time from the instant of turning on XO circuit to the first rising edge of XO divider clock output. The external microcontroller turns on the XO by,

- 1. Sending a wakeup pulse for MAX41461–MAX41464 in the preset mode, or
- 2. Writing to device I²C address for MAX41461–MAX41464 in the I²C mode, or
- 3. Pulling CSB pin low on the MAX41460.

Crystal Divider

The recommended crystal frequencies are 13.0MHz, 16.0MHz, and 19.2MHz. An internal clock of 3.2MHz ± 0.1 MHz frequency is required. To maintain the internal 3.2MHz time base, XOCLKDIV[1:0] (register CFG1, 0x00, bit 4) must be programmed, based on the crystal frequency, as shown in Table 3.

Table 3. Required Crystal Divider Programming

CRYSTAL FREQUENCY (MHz)	Crystal Divider Ratio	XOCLKDIV[1:0]
13.0	4	00
16.0	5	01
19.2	6	10

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Phase-Locked Loop (PLL)

The MAX41460 utilizes a fully integrated fractional-N PLL for its frequency synthesizer. All PLL components, including loop filter, are included on-chip. The synthesizer has a 16-bit fractional-N topology with a divide ratio that can be set from 11 to 72, allowing the transmit frequency to be adjusted in increments of $f_{TAL}/65536$. The fractional-N architecture also allows exact FSK frequency deviations to be programmed. FSK deviations as low as ±1kHz and as high as ±100kHz can be set by programming the appropriate registers.

The internal VCO can be tuned continuously from 286MHz to 960MHz in normal mode, and from 286MHz–320MHz, 425MHz–480MHz, and 860MHz–960MHz in low phase noise mode.

Frequency Programming

The desired frequency can be programmed by setting bits FREQ in registers PLL3, PLL4, and PLL5 (0x0B, 0x0C, 0x0D). To calculate the FREQ bits, use:

 $\mathsf{FREQ}[23:0] = \mathsf{ROUND}\left(\frac{\frac{65536 \times f_C}{f_{\mathsf{XTAL}}}}\right)$

See <u>Table 4</u> to program the LODIV bits in register PLL1 (0x08) when choosing a LO frequency. It is recommended to leave bits CPVAL and CPLIN at factory defaults. If integer-N synthesis is desired, set bit FRACMODE = 0 in register PLL1.

Table 4. LODIV Setting

FREQUENCY RANGE (MHz)	LODIV SETTING
286–960, Low Current Mode	0x0
286–320, Low Phase Noise Mode	0x3
425–480, Low Phase Noise Mode	0x2
860–960, Low Phase Noise Mode	0x1

Fractional-N Spurs

The 16-bit fractional-N, delta-sigma modulator can produce spurious that can show up on the power amplifier output spectrum. If slight frequency offsets can be tolerated, set the LSB of FREQ (register PLL5, bit 0) to logic-high. Using an odd value (logic 1 at bit 0) of the 24-bit FREQ register will produce lower PLL spurious compared to even values (logic 0 at bit 0).

Turn-On Time of PLL

The turn-on time of PLL, t_{PLL}, is defined as the elapsed time from the instant when the XO output is available to the instant when PLL frequency acquisition is complete.

Serial Peripheral Interface (SPI)

The MAX41460 utilizes a 3-wire SPI protocol for programming its registers, configuring and controlling the operation of the whole transmitter. The register contents may be read back through the CLKOUT/SDO pin. The digital I/Os in <u>Table 5</u> control the operation of the SPI.

Table 5. SPI Controls

PIN	DESCRIPTION
SCLK	SPI Clock
DATA/SDI	SPI Data Input
CSB	SPI Chip-Select Bar
CLKOUT/SDO	SPI Data Out

To help ensure the MAX41460 powers on in its low power state, an internal pullup resistor of approximately $200k\Omega$ is connected to pin CSB. For example, if the microcontroller GPIO is high-impedance at power on, CSB will follow V_{DD} to make sure the MAX41460 does not enter the PLL ready state.

Figure 3 shows the general SPI Write transaction. Figure 4 shows the format of a 4-wire SPI Read transaction. In order to change CLKOUT to SDO, the user must set the FOURWIRE bit (register CFG6, address 0x0A, bit 0) to the value of 1.

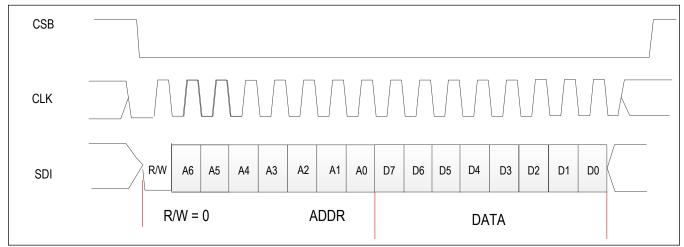


Figure 3. 3-Wire SPI Write

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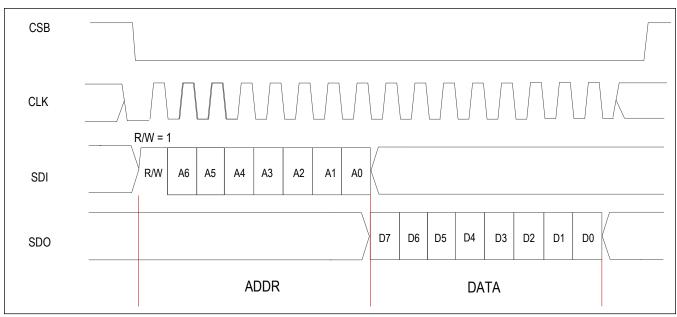


Figure 4. 4-Wire SPI Read

Asynchronous and Synchronous Transmission

The MAX41460 is configured to synchronous or asynchronous transmission mode when SYNC (register CFG1, 0x00, bit 1) is set or cleared.

In synchronous transmission mode, the MAX41460 outputs a baud-rate clock with 50% duty cycle on the CLKOUT/SDO pin. A microcontroller can use the rising edge of CLKOUT as the interrupt source for DATA generation from an interrupt service routine. The MAX41460 resamples input DATA at the falling edge of baud-rate clock to minimize jitter. The baud rate is programmable by BCLK_PREDIV[7:0] (register CFG3, 0x02, bits 7:0) and BCLK_POSTDIV[2:0] (register CFG2,, 0x01, bits 2:0) as the following expression:

BaudRate = $\frac{f_{CLK}}{2 \times (1 + BCLK_{PREDIV}) \times 2^{BCLK_{POSTDIV}}}$

where f_{CLK} is the crystal-divider output clock rate (nominally, 3.2 MHz). Valid values of BCLK_PREDIV are from 3 to 255. Valid values of BCLK_POSTDIV are from 1 to 5.

In asynchronous transmission mode (also called baud-rate transparent mode), the baud rate of data transmission is fully controlled by the microcontroller, and the DATA input is transferred to internal 3.2MHz clock domain by D-flip-flop synchronizers. The MAX41460 still provides programmable CLKOUT in asynchronous transmission mode, but the microcontroller does not have to use the CLKOUT signal.

Buffered Clock Output

The MAX41460 provides CLKOUT on pin 6 of the chip in the three-wire SPI mode. The CLKOUT frequency of MAX41460 is programmable (see the <u>Asynchronous and Synchronous Transmission</u> section).

There is no CLKOUT in the four-wire SPI mode, where pin 6 is reused as the SDO line. In four-wire SPI mode, pin 6 is disconnected (high-impedance output) when CSB is logic-high.

CLKOUT_DELAY[1:0] (register CFG2, address 0x01, bits 7:6) are not to be used in the MAX41460.

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State Diagrams

The MAX41460 has four major operating states: shutdown, standby, programming, and transmitter-enabled. These states describe the power-on/power-off status of the transmitter's three primary internal circuit blocks: the crystal oscillator (XO), the PLL synthesizer, and the power amplifier (PA).

Table 6. State Descriptions

STATE	хо	PLL	РА
Shutdown	Off	Off	Off
Standby	On	Off	Off
Programming	On	On	Off
Transmitter-Enabled	On	On	On with Ramp-up

Configuration register values are retained in all states unless changed by programming, or if the device is powered off or undergoes a SOFTRESET.

Right after power-on, the MAX41460 enters the shutdown state. A falling edge on CSB (pin 9) initiates the warm-up of XO and PLL.

The device can support two types of SPI transactions: register access only, and register access followed by data transmission. The event trigger of data transmission is a rising edge on SPI_TXEN, which is a special register bit with two aliases SPI_TXEN1 (register CFG6, 0x0A, bit 1) and SPI_TXEN2 (register CFG7, 0x10, bit 1). A rising edge on SPI_TXEN can be generated by clearing SPI_TXEN1 and setting SPI_TXEN2 in a single SPI transaction.

After a rising edge of CSB, which indicates end-of-transmission, the MAX41460 refers to PWDN_MODE[1:0] (register CFG4, 0x03, bits 1:0) to enter the shutdown, standby, or programming state. The shutdown and standby states can only be entered after the transmitter-enabled state.

SPI_TXEN is automatically cleared in two cases: 1) wake-up from shutdown, 2) return to programming state from the transmitter-enabled state. In those two cases, a rising edge on SPI_TXEN can be generated by setting SPI_TXEN2 in CFG7, without explicit clearing of SPI_TXEN1.

In both shutdown and standby states, programming through the SPI interface is not allowed. The MAX41460 will leave the shutdown or standby state once a falling CSB is detected.

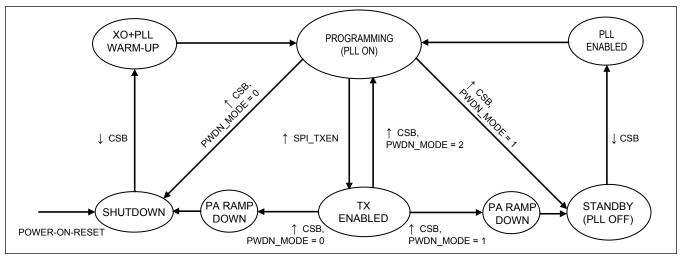


Figure 5. Simplified State Diagram of the MAX41460

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Initial Programming

After turning on power supply (or after a soft reset), an SPI transaction that burst-writes 17 consecutive registers from address 0x00 to 0x10 is required to initialize the PLL frequency synthesizer.

The initial programming must clear MODMODE (register CFG1, address 0x00, bit 0), clear SPI_TXEN1 (register CFG6, address 0x0A, bit 1), configure FREQ[23:0] (register PLL3, PLL4 and PLL5) to desired frequency, and set SPI_TXEN2 (register CFG7, address 0x10, bit1).

With this process there are two timing requirements:

1) From transaction start to the SPI_TXEN bit write, the time lag must be longer than the XO turn-on time (t_{XO}).

2) From SPI_TXEN bit write to transaction end, the time lag must be longer than the PLL turn-on time (t_{PLL})

It takes 144 SCLK cycles to burst-write 17 consecutive registers. To meet requirement 1), the master device can lower the SCLK frequency or delay the start of register programming after chip select.

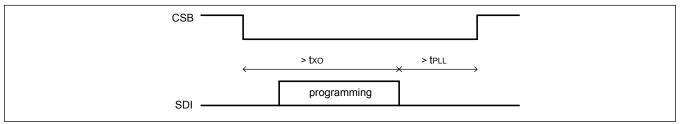


Figure 6. Initial Programming of MAX41460 by a Single SPI Transaction

After initial programming, the MAX41460 device will enter the shutdown, standby, or programming state according to the setting of PWDN_MODE[1:0] (register CFG4, address 0x03, bit[1:0]).

Startup

This section assumes that initial programming is done after power-on (or soft reset). There is no RF emission at the PA output during initial programming. Configuration register values are retained in all states, unless changed by programming, if the device is powered off, or undergoes a SOFTRESET.

Case 1: Using Two SPI Transactions, for Configuration then Transmission, from Shutdown State

The startup of the MAX41460 from the shutdown state can use two SPI transactions: one for configuration update and the other for data transmission. Note that FSK modulation can only be enabled through a configuration update because the initial programming must clear MODMODE (register CFG0, address 0x00, bit 0).

In the first SPI transaction, the master device burst-writes consecutive registers that are a portion or all of the 16 registers from address 0x00 to 0x0F. Those consecutive registers may or may not include CFG6. If CFG6 is included, the SPI_TXEN1 bit should be cleared. Otherwise, SPI_TXEN1 is automatically cleared in the wake-up from shutdown.

In the second SPI transaction, the master device can set SPI_TXEN2 (register CFG7, address 0x10, bit 1), wait for at least t_{TX} time, and then start data transmission. For applications without frequency-hopping, t_{TX} is 10µs.

The event trigger for wake-up is the falling edge of CSB of the first transaction. The event trigger for data transmission is the rising edge of SPI_TXEN that has two aliases of SPI_TXEN1 and SPI_TXEN2. The time lag between those two triggers must be longer than t_{XO} + t_{PLL} . To meet this requirement, the master device can adjust the waiting time between two SPI transactions.

The MAX41460 provides a CLKOUT signal with programmable frequency. The time lag (t_{CKO}) from transmission trigger to the first edge of CLKOUT does not vary with CLKOUT frequency.

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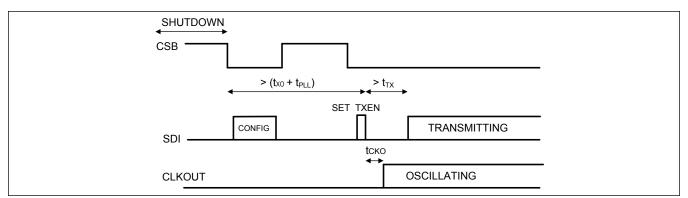


Figure 7. Using Two SPI Transactions to Start Data Transmission from the Shutdown State.

Case 2: Using a Single SPI Transaction for Configuration and Transmission, from Shutdown State

The startup of the MAX41460 from the shutdown state may also use a single SPI transaction with configuration update followed by data transmission. The master device can burst-write a number of consecutive registers, where the last register should be CFG7 to set SPI_TXEN2. The consecutive registers may or may not include CFG6. If CFG6 is included, SPI_TXEN1 should be cleared.

The event trigger for wake-up is the falling edge of CSB. The event trigger for data transmission is the rising edge of SPI_TXEN that has two aliases of SPI_TXEN1 and SPI_TXEN2. The time lag between those two triggers must be longer than $t_{XO} + t_{PLL}$. To meet this requirement, the master device can extend the SCLK period used during register programming or insert a delay between chip select and programming start. After setting SPI_TXEN2, the master device can wait for at least t_{TX} time and start data transmission.

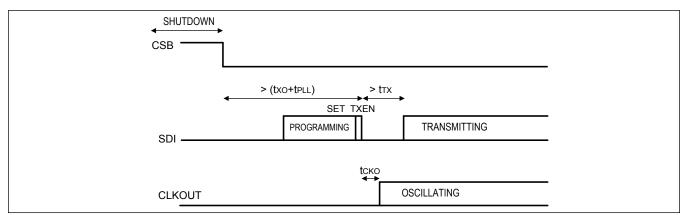


Figure 8. Using a Single SPI Transaction to Start Data Transmission from the Shutdown State.

Case 3: Using a Single SPI Transaction for Configuration and Transmission, from Standby State

The startup of the MAX41460 from the standby state can use a single SPI transaction with configuration update followed by data transmission. In the programming for configuration update, the master device should burst-write at least 7 consecutive registers, where CFG7 is the last register to write. The first register to write can be CFG6 or any register preceding CFG6. The programming should clear SPI_TXEN1 and set SPI_TXEN2.

The event trigger for wake-up is the falling edge of CSB. The event trigger for data transmission is the rising edge of

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SPI_TXEN that has two aliases of SPI_TXEN1 and SPI_TXEN2. The time lag between those two triggers must be longer than t_{PLL} for startup from standby. To meet this requirement, the master device can extend the SCLK period used during register programming or insert a delay between chip select and programming start. After setting SPI_TXEN2, the master device can wait for at least t_{TX} time and start data transmission.

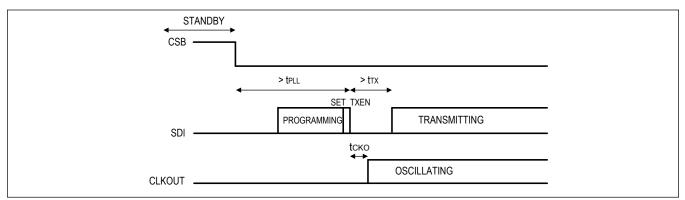


Figure 9. Using a Single SPI Transaction to Start Data Transmission from the Standby Mode.

Case 4: Using a Single SPI Transaction for Configuration and Transmission, from Programming State

The MAX41460 device can transmit a data packet each time in the transmitter-enabled state. After data transmission, the device refers to the setting of PWDN_MODE[1:0] to enter the shutdown, standby, or programming state. If the next data packet requires very fast startup, PWDN_MODE[1:0] can be configured to 0x10 so that the MAX41460 device returns to the programming state when the RF transmission is complete.

Then, the master device can use a single SPI transaction to start data transmission. There is no restrictions arising from t_{XO} and t_{PLL} . Without configuration update, the master device can write only one register CFG7 to set SPI_TXEN2. If configuration update is required, the master device should burst-write consecutive registers, where CFG7 is the last register to write. Those consecutive registers may or may not include CFG6. If CFG6 is included, the SPI_TXEN1 bit should be cleared. Otherwise, SPI_TXEN1 is automatically cleared.

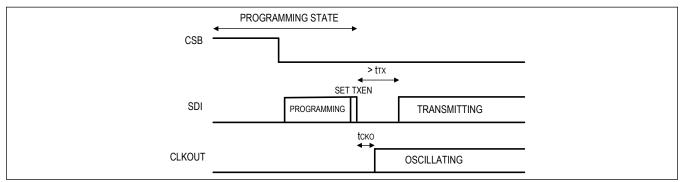


Figure 10. Using a Single SPI Transaction to Start Data Transmission from the Programming State.

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Frequency-Hopping

The frequency synthesizer is initialized at a frequency in a selected ISM band by Initial Programming. After that, for the purpose of frequency dithering or frequency hopping, the FREQ[23:0] registers can be updated to a new frequency in the same selected band for each data packet to be transmitted.

Because programming is not allowed in the transmitted-enabled state (see the <u>State Diagrams</u> section), frequency configuration cannot be changed when PA is enabled. See the <u>Startup</u> section for details on how to program the device for data transmission.

After transmitting a data packet, the MAX41460 device enters the shutdown, standby, or programming state according to the setting of PWDN_MODE[1:0] register. The three options have different startup time for transmitting the the next data packet. The startup time from shutdown is at least ($t_{XO} + t_{PLL} + t_{TX}$), where t_{XO} is the turn-on time of crystal oscillator, t_{PLL} is the turn-on time of PLL, t_{TX} is the turn-on time of transmitter. The startup time from standby is at least ($t_{PLL} + t_{TX}$).

The t_{TX} time is 10µs if frequency hops are no more than 1MHz per hop. If the frequency hop is as high as 26MHz, as in the case of 902MHz~928MHz band, then the t_{TX} time is 20µs. Refer to the <u>Electrical Characteristics</u> table for typical values of t_{XO} and t_{PLL} .

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Register Map

Register Map

ADDRESS	NAME	MSB							LSB	
тх			I	L	1		1			
0x00	<u>CFG1[7:0]</u>	XOCLKD	ELAY[1:0]	XOCLK	DIV[1:0]	-	FSKSHA PE	<u>SYNC</u>	MODMO DE	
0x01	<u>CFG2[7:0]</u>		<u>DELAY[1:</u>)]	_	-	-	RESERVED[2:0]			
0x02	CFG3[7:0]				RESER'	VED[7:0]				
0x03	CFG4[7:0]	_	-	-	-	-	-	PWDN_N	10DE[1:0]	
0x04	CFG5[7:0]	-	-			TSTE	P[5:0]			
0x05	<u>SHDN[7:0]</u>	-	-	-	-	-	RESERV ED	RESERV ED	<u>PA_BOO</u> <u>ST</u>	
0x06	PA1[7:0]	RE	ESERVED[2	:0]	_	-	PAPWR[2:0]			
0x07	PA2[7:0]	_	_	_			PACAP[4:0]	1		
0x08	PLL1[7:0]	CPLI	N[1:0]	FRACM ODE	RESER'	VED[1:0]	LODI	V[1:0]	LOMOD E	
0x09	PLL2[7:0]	RESERV ED	RESERV ED	-	_			<u>CPVA</u>	<u>CPVAL[1:0]</u>	
0x0A	<u>CFG6[7:0]</u>	-	-	-	-	-	RESERV ED	SPI_TXE <u>N1</u>	FOURWI <u>RE1</u>	
0x0B	PLL3[7:0]				FREQ	[23:16]				
0x0C	PLL4[7:0]				FREG	Q[15:8]				
0x0D	PLL5[7:0]				FRE	<u> 2[7:0]</u>				
0x0E	PLL6[7:0]	_			ļ	DELTAF[6:(<u>)]</u>			
0x0F	PLL7[7:0]	_	-	-	-		DELTAF_S	SHAPE[3:0]		
0x10	<u>CFG7[7:0]</u>	-	-	-	-	-	RESERV ED	<u>SPI_TXE</u> <u>N2</u>	FOURWI RE2	
0x17	<u>CFG8[7:0]</u>	_	_	-	_	-	-	_	SOFTRE SET	
0x18	<u>CFG9[7:0]</u>		RESERVED[4:0] RESERV ED ED					RESERV ED		
0x19	ADDL1[7:0]	RESER	VED[1:0]	RESER	VED[1:0]	RESER	VED[1:0]	RESER	VED[1:0]	
0x1A	ADDL2[7:0]	RESERV ED			RE	ESERVED[<u>6:0]</u>			

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Register Details

<u>CFG1 (0x00)</u>

BIT	7	6	5	4		3	2	1	0	
Field	XOCLKDE	LAY[1:0]	XOCLK	DIV[1:0]		-	<u>FSKSHAPE</u>	<u>SYNC</u>	MODMODE	
Reset	0x:	2	0:	x1		-	0b0	0b0	0b0	
Access Type	Write,	Read	Write,	Read		_	Write, Read	Write, Read	Write, Read	
BITFIELD	BITS		DESCRIPT	ION			DECODE			
XOCLKDELA Y	7:6	Start delay t block	Start delay before enabling XO clock to digital block 0x0: No delay. XO clock is immediately en- rest of digital block 0x1: XO clock is enabled after 16 cycles t digital block 0x2: XO clock is enabled after 32 cycles t digital block 0x3: XO clock is enabled after 64 cycles t digital block							
XOCLKDIV	5:4	XO clock div	XO clock division ratio for digital block			0x0: Divide XO clock by 4 for digital clock 0x1: Divide XO clock by 5 for digital clock. High time is 2 cycles, low time is 3 cycles 0x2: Divide XO clock by 6 for digital clock 0x3: Divide XO clock by 7 for digital clock. High time is 3 cycles, and low time is 4 cycles				
FSKSHAPE	2	Sets the sta	Sets the state of FSK Gaussain Shaping 0x0: FSK Shaping disabled 0x1: FSK Shaping enabled							
SYNC	1		clock output acts as an input. 0x0 nput, it will sample the DATA pin. 0x1							
MODMODE	0	Configures I	modulator mod	е		0x0: AS 0x1: FS				

<u>CFG2 (0x01)</u>

BIT	7	6	5	4		3	2	1	0	
Field		DELAY[1:0] – – – – <u>RESERVED[2:0</u>			1					
Reset	0x	2	-	-		-		0x1		
Access Type	Write,	Read	-	-		-	Write, Read			
BITFIELD	BITS		DESCRIPT	ION		DECODE				
CLKOUT_DE LAY	7:6			KOUT starts IDOWN mode,	in	whenever mode 0x1: CLI whenever mode 0x2: CLI	KOUT will start er moving into r KOUT will start er moving into r KOUT will start er moving into r	normal mode fr toggling after ' normal mode fr toggling after 2	om shutdown 128 cycles om shutdown 256 cycles	

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BITFIELD	BITS	DESCRIPTION	DECODE
			0x3: CLKOUT will start toggling after 512 cycles whenever moving into normal mode from shutdown mode
RESERVED	2:0	Write to 000 binary.	

CFG3 (0x02)

BIT	7	6	5	4	3	2	1	0		
Field				RESER	/ED[7:0]					
Reset		0x3								
Access Type		Write, Read								
BITFIELD	BITS		DESCRIPTION DECODE							
RESERVED	7:0	Write to 00 h	ıex.							

CFG4 (0x03)

BIT	7	6	5	4	3	2	1	0
Field	-	-	-	-	-	-	PWDN_MODE[1:0]	
Reset	-	-	-	-	-	-	0x0	
Access Type	-	-	_	-	_	-	Write, Read	

BITFIELD	BITS	DESCRIPTION	DECODE
PWDN_MOD E	1:0	Power Down Mode Select	0x0: SHUTDOWN low power state is enabled. While entering low power state, XO, PLL, and PA are shutdown. 0x1: STANDBY low power state is enabled. While entering low power state, XO is enabled. PLL and PA are shutdown 0x2: FAST WAKEUP low power state is enabled. While entering low power state, XO and PLL are enabled. PA is shutdown. 0x3: Will revert to 0x2

<u>CFG5 (0x04)</u>

BIT	7	6	5	4	3	2	1	0			
Field	-	-		TSTEP[5:0]							
Reset	-	-	0x00								
Access Type	_	-	Write, Read								
BITFIEI	LD	BITS	DESCRIPTION								
TSTEP		5:0	Controls GFSK shaping. See Digital FSK Modulation section.								

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SHDN (0x05)

BIT	7	6	5	4		3	2	1	0		
Field	-	-	-	-		-	RESERVED	RESERVED	PA_BOOST		
Reset	-	-	-	-		-	0x1	0x0	0x0		
Access Type	-	-	-	-		_	Write, Read	Write, Read	Write, Read		
BITFIELD	BITS		DESCRIPT	ION			D	DECODE			
RESERVED	2	Write to 1 bi	nary.			1					
RESERVED	1	Write to 0 bi	nary.			0					
PA_BOOST	0	frequencies	Enables a boost in PA output power for frequencies above 850MHz. This requires a different PA match compared to normal				0x0: PA Output power in normal operation. 0x1: PA Output power in boost mode for more output power.				

PA1 (0x06)

BIT	7	6	5	4	3	2	1	0
Field	E	RESERVED[2:0	1	-	-	<u>PAPWR[2:0]</u> 0x0		
Reset		0x4		-	-			
Access Type		Write, Read		-	-	Write, Read		

BITFIELD	BITS	DESCRIPTION	DECODE
RESERVED	7:5	Write to 100 binary.	100
PAPWR	2:0	Controls the PA output power by enabling parallel drivers.	0x0: Minimum, 1 driver 0x1: 2 Drivers 0x2: 3 Drivers 0x3: 4 Drivers 0x4: 5 Drivers 0x5: 6 Drivers 0x6: 7 Drivers 0x7: 8 Drivers

PA2 (0x07)

BIT	7	6	5	4 3 2 1 0						
Field	-	-	-	PACAP[4:0]						
Reset	-	-	-			0x0				
Access Type	_	_	_	Write, Read						
BITFIELD	BITS		DESCRIPT	ION		D	ECODE			
PACAP	4:0	Controls shu fF.	unt capacitance	e on PA output	0x00: 0x01: 0x02: 0x02: 0x04: 0x04: 0x05: 0x06: 0x06: 0x07:	175 350 525 700 875 1050				

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BITFIELD	BITS	DESCRIPTION	DECODE
			0x08: 1400
			0x09: 1575
			0x0A: 1750
			0x0B: 1925
			0x0C: 2100
			0x0D: 2275
			0x0E: 2450
			0x0F: 2625
			0x10: 2800
			0x11: 2975
			0x12: 3150
			0x13: 3325
			0x14: 3500
			0x15: 3675
			0x16: 3850
			0x17: 4025
			0x18: 4200
			0x19: 4375
			0x1A: 4550
			0x1B: 4725
			0x1C: 4900
			0x1D: 5075
			0x1E: 5250
			0x1F: 5425

PLL1 (0x08)

BIT	7	6	5	4		3	2	1	0		
Field	CPLI	N[1:0]	FRACMOD E	RESERVED[1:0]			LODI	LOMODE			
Reset	0>	:1	0x1	0x	00		0	x0	0b0		
Access Type	Write,	Read	Write, Read	Write, Read			Write, Read		Write, Read		
BITFIELD	BITS		DESCRIPT	ION			D	ECODE			
CPLIN	7:6	for fractiona	for fractional N mode to improve close in phase noise. Set to 'DISABLED' for integer N				0x0: No extra current 0x1: 5% of charge pump current 0x2: 10% of charge pump current 0x3: 15% of charge pump current				
FRACMODE	5	Sets PLL be mode.	tween fractiona	al-N and intege	r-N	0x0: Integer N Mode 0x1: Fractional N Mode					
RESERVED	4:3	Write to 00 b	oinary.			00					
LODIV	2:1						abled VCO divided b VCO divided b VCO divided b	by 8			
LOMODE	0	choose LOV	neration. For lo VCURRENT. Fo e, choose LOW	or higher		0x0: Ring Oscillator Mode 0x1: LC VCO Mode					

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PLL2 (0x09)

BIT	7	6	5 4		3	2	1	0		
Field	RESERVED	RESERVED	-	-	-	-	<u>CPVA</u>	L[1:0]		
Reset	0x0	0b0	-	-	-	-	0	k0		
Access Type	Write, Read	Write, Read	-	_	_	– – Write				
BITFIELD	BITS		DESCRIPT	ION		DECODE				
RESERVED	7	Write to 0 bi	nary.		0	0				
RESERVED	6	Write to 0 bi	nary.		0	0				
CPVAL	1:0	Sets Charge	Pump Curren	t	0x0: 5µ/ 0x1: 10µ 0x2: 15µ 0x3: 20µ	μΑ μΑ				

<u>CFG6 (0x0A)</u>

BIT	7	6	5	4	3		2	1	0
Field	-	-	-	-	-		RESERVED	<u>SPI_TXEN1</u>	FOURWIRE
Reset	-	_	_	-	_		0x0	0x0	0x0
Access Type	-	-	-	-	_		Write, Read	Write, Read	Write, Read
BITFIELD	BITS		DESCRIPT	ION			DI	ECODE	
RESERVED	2	Write to 0 bi	nary.						
SPI_TXEN1	1	Transmissio	Transmission enable.				Insmission disa		
FOURWIRE1	0	Four wire rea	Four wire readback on CLKOUT pin mode.				ur wire readbac ur wire readbac		

PLL3 (0x0B)

BIT	7	7 6 5 4 3 2 1										
Field		FREQ[23:16]										
Reset		0x13										
Access Type		Write, Read										
BITFIEI	D	BITS DESCRIPTION										
FREQ		7:0	FREG	FREQ value to PLL. LO frequency= FREQ<23:0>/2^16*fXTAL								

PLL4 (0x0C)

BIT	7	6	5	4	3	2	1	0			
Field		FREQ[15:8]									
Reset		0xB0									
Access Type	Write, Read										

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BITFIELD	BITS	DESCRIPTION
FREQ	7:0	FREQ value to PLL

PLL5 (0x0D)

BIT	7	6 5 4 3 2 1										
Field		<u>FREQ[7:0]</u>										
Reset		0x00										
Access Type		Write, Read										
BITFIE	LD	BITS		DESCRIPTION								
FREQ		7:0	FRE	FREQ value to PLL								

PLL6 (0x0E)

BIT	7	6	5	4	3	2	1	0		
Field	-		DELTAF[6:0]							
Reset	_		0x28							
Access Type	_		Write, Read							
BITFIEI	D	BITS			DE	SCRIPTION				
DELTAF 6:0 For FSK mode, MODMODE=1 and FSKSHAPE=0, sets the frequency deviation from the space frequency for the mark frequency. fDELTAF DELTAF 0:0 * fXTAL/ 8192										

PLL7 (0x0F)

BIT	7	6	5		4	3	2	1	0	
Field	-	-	-		-	DELTAF_SHAPE[3:0]				
Reset	-	-	-		-	0x4				
Access Type	_	-	-		_	Write, Read				
BITFIEI	LD	BITS				DE	SCRIPTION			
DELTAF_SHA	PE	3:0		devia	FSK mode, MODMODE = 1 and FSKSHAPE = 1, sets the frequency iation from the space frequency for the mark frequency. fDELTA =					

<u>CFG7 (0x10)</u>

BIT	7	6	5	4		3	2	1	0
Field	-	-	_	_		-	RESERVED	SPI_TXEN2	FOURWIRE
Reset	-	_	-	-		-	0x0	0x0	0x0
Access Type	_	_	_	_		_	Write, Read	Write, Read	Write, Read
BITFIELD	BITS		DESCRIPTION				D	ECODE	
RESERVED	2	Write to 0 binary.							

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BITFIELD	BITS	DESCRIPTION	DECODE
SPI_TXEN2	1	0x0: Transmission disabled. 0x1: Transmission enabled.	
FOURWIRE2	0	Four wire readback on CLKOUT pin mode. Aliased address for FOURWIRE1	0x0: Four wire readback disabled. 0x1: Four wire readback enabled.

CFG8 (0x17)

BIT	7	6	5	4		3	2	1	0
Field	-	-	_	_		_	-	_	SOFTRESE I
Reset	-	_	-	_		-	_	-	0b0
Access Type	-	_	_	_		_	_	-	Write, Read
BITFIELD	BITS		DESCRIPTION				D	ECODE	
SOFTRESET	0	Places DUT into software reset.				assert the rese sets the entire	t digital, until this	s bit is set to	

CFG9 (0x18)

BIT	7	6	5	4	3	2	1	0
Field		RESERVED[4:0]					RESERVED	RESERVED
Reset		0x0					0x0	0x0
Access Type		Write, Read					Write, Read	Write, Read
BITFIELD	BITS	BITS DESCRIPTION				D	ECODE	
RESERVED	7:3	Write to 0_0	000 binary.		00000)		
RESERVED	2	Write to 0 binary.			0			
RESERVED	1	Write to 0 binary.			0			
RESERVED	0	0 Write to 0 binary.			0			

ADDL1 (0x19)

BIT	7	6	5	4	3	2	1	0	
Field	RESER\	/ED[1:0]	RESERVED[1:0]		RESERVED[1:0]		RESERVED[1:0]		
Reset	0>	(0	0x0		0:	0x0		(0	
Access Type	Write,	Read	Read Write, Read		Write,	Write, Read		Read	
BITFIELD	BITS		DESCRIPTION			DECODE			
RESERVED	7:6	Write to 00 b	oinary.		00	00			
RESERVED	5:4	Write to 00 b	Write to 00 binary.			00			
RESERVED	3:2	Write to 00 b	Write to 00 binary.			00			
RESERVED	1:0	Write to 00 k	Write to 00 binary.						

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ADDL2 (0x1A)

BIT	7	6	5	4	3	2	1	0	
Field	RESERVED		RESERVED[6:0]						
Reset	0x1		0x0						
Access Type	Write, Read	Write, Read							
BITFIELD	BITS		DESCRIPTION DECODE						
RESERVED	7	Write to 1 binary. 1							
RESERVED	6:0	Write to 000_0000 binary. 0000000							

Applications Information

Power-On Programming

To ensure the MAX41460 device enters the shutdown state after power on, the DATA pin must be held low at power on. If the DATA pin cannot be guaranteed low at power on, then the use of a high value pulldown resistor is recommended. After V_{DD} has settled, a logic low-high-low transition must occur on the DATA pin to properly enter the shutdown state and the CSB pin does not need to be exercised during this operation.

After turning on the power supply (or after a soft reset), a SPI transaction that burst-writes 17 consecutive registers from address 0x00 to 0x10 is required to initialize the PLL frequency synthesizer. See the *Initial Programming* section.

For example, the crystal frequency is 16MHz, the RF frequency is 315MHz, the 17 consecutive registers can be configured as:

[0x90, 0x81, 0x03, 0x00, 0x00, 0x04, 0x80, 0x80, 0x60, 0x00, 0x00, 0xC4, 0xDE, 0x98, 0x28, 0x04, 0x02].

After initial programming, the device will enter the shutdown, standby, or programming state according to the setting of PWDN_MODE[1:0] (register CFG4, address 0x03, bit[1:0]). Configuration register values are retained in all states unless changed by programming, or if the device is powered off or undergoes a SOFTRESET. See the <u>Startup</u> section for how to program the device for data transmission.

ASK Carrier Frequency

The ASK carrier frequency is set by the FREQ bits in registers 0x0B, 0x0C, and 0x0D. The user calculates the divide ratio based on the carrier frequency and crystal frequency. The following equation shows how to determine the correct value to be loaded into the FREQ registers.

$$FREQ = \left(\frac{fRF}{fXTAL}\right) \times 65536$$

For example, the desired ASK transmit frequency is 315MHz and the crystal frequency is 16MHz. 315/16 is 19.6875. 19.6875×65536 is 1290240. Converted into hex, the value is 0x13B000. This value is loaded into FREQ[23:0]. In the case where the value is non-integer, the value may be rounded to the nearest integer.

Digital FSK Modulation

The FSK modulation in MAX41460 is defined by the space frequency and the mark frequency. The space frequency is the lower frequency that represents a logic 0. The mark frequency is the higher frequency that represents a logic 1. The device defaults to Gaussian filtered frequency shaping to help reduce spectral emissions.

The space frequency is defined by the FREQ[23:0] bits (registers PLL3, PLL4, PLL5). To set the space frequency, use the following equation:

 $\mathsf{FREQ}[23:0] = \frac{65536 * f_{\mathsf{SPACE}}}{f_{\mathsf{XTAL}}}$

The mark frequency is defined by the space frequency plus a frequency deviation. If frequency shaping is disabled by setting FSKSHAPE = 0 (register CFG1, bit 2), the frequency deviation is defined by DELTAF[6:0] (register PLL6, bits 6:0).

 $\mathsf{DELTAF}[6:0] = \frac{f_{\Delta} * 8192}{f_{\mathsf{XTAL}}}$

If frequency shaping is enabled by setting FSKSHAPE = 1 (register CFG1, bit 2), the frequency deviation is defined by DETLAF_SHAPE[3:0] (register PLL7, bits 3:0).

$$\mathsf{DELTAF_SHAPE[3:0]} = \frac{f_{\Delta} * 8192}{f_{\mathsf{XTAL}} * 10}$$

When FSK shaping is enabled by setting FSKSHAPE = 1, the frequency is transitioned in 16 steps between the two

frequencies using a Gaussian filter shape. The time between each step is controlled by TSTEP[5:0] (register CFG5, bits 5:0). The time step can be adjusted based on the data rate.

TSTEP[5:0] = minimum $\left(64, \text{ floor}\left(\frac{200000}{f_{\text{DATA}_{\text{RATE}}}}\right)\right) - 1$

where $f_{DATARATE}$ has a unit of bits per second. For example, if $f_{DATARATE}$ is 47kbps, then TSTEP is floor (200000/ 47000) - 1 = 3.

In the preset mode, the frequency deviation is fixed at 78kHz.and TSTEP = 1.

FSK shaping supports a data rate up to 110kbps. Higher data rates is not recommended.

Tuning Capacitor Settings

The internal variable shunt capacitor, which can be used to match the PA to the antenna with changing transmitter frequency, is controlled by setting the 5-bit cap variable in the registers. This allows for 32 levels of shunt capacitance control. Since the control of these 5 bits is independent of the other settings, any capacitance value can be chosen at any frequency, making it possible to maintain maximum transmitter efficiency while moving rapidly from one frequency to another. The internal tuning capacitor adds 0 to 5.425pF to the PA output in 0.175pF steps.

Crystal Frequency Selection

In order to avoid integer boundary spurs in fractional-N PLL synthesizers, the crystal should be selected so that the RF carrier frequency is more than 0.4 MHz apart from the nearest integer multiple of crystal frequency.

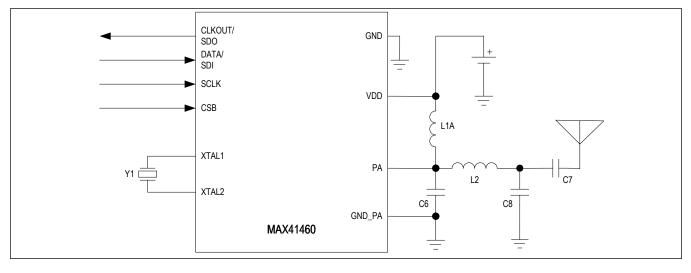
For example, the 16±0.002MHz crystals can be selected for the 433.92 MHz RF carrier, which is more than 0.4MHz apart from the nearest integer multiple of crystal frequency at 432±0.054MHz. However, the 16±0.002MHz crystals are not suitable for a RF carrier at 912MHz or 928MHz.

The crystal divider ratio should be programmed so that the divided clock frequency is 3.2±0.1MHz. In addition, the PLL synthesizer requires a reference frequency (same as crystal frequency) between 12.8MHz and 19.2MHz. Therefore, when crystal divider ratio is 4, 5, or 6, allowed range of crystal frequency is 12.8MHz~13.2MHz, 15.5MHz~16.5MHz, or 18.6MHz~19.2MHz.

In another example, desired RF frequencies are 319.5MHz, 345.0MHz and 433.92MHz, and recommended crystal selection is 13±0.002MHz so that integer boundary spurs are completely suppressed for three desired RF frequencies. Nevertheless, the 16±0.002MHz and 19.2±0.002MHz crystals are also acceptable.

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Typical Application Circuit



Ordering Information

PART NUMBER	TEMPERATURE RANGE	PIN-PACKAGE
MAX41460GUB+	-40°C to +105°C	10 µMAX
MAX41460GUB+T	-40°C to +105°C	10 µMAX

+Denotes a lead(Pb)-free/RoHS-compliant package.

T = Tape-and-reel.

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Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	10/18	Initial release	—
1	2/19	Updated Figure 3 and Figure 4	17, 18
2	3/19	Updated TSSOP references to µMAX	1, 2, 11, 13, 36

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